

Docket No.: JCLA10375-D

Date: March 22, 2004

COMMISSIONER FOR PATENTS
P.O. BOX 1450
ALEXANDRIA, VA 22313-1450

ATTENTION: APPLICATION BRANCH

Sir:

This is a request for filing a continuation application under 37 CFR 1.53 (b) as a **divisional application** of prior application No. **10/447,520** filed on **May 28, 2003**.

Prior application information: **Examiner:** LUU, CHUONG A. ; **Group Art Unit:** 2825

The entire disclosure of the prior application, from which an oath or declaration is supplied herewith as indicated below, is considered a part of the disclosure of the accompanying continuation or divisional application and is hereby incorporated by reference.

Transmitted herewith for filing is the patent application of

Inventor(s): YU-LUNG YU ;
JOSEPH NEE ;

For: WAFER LEVEL TESTING AND BUMPING PROCESS

Enclosed are:

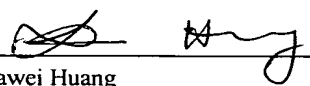
- (X) Specification in FIFTEEN (15) pages.
- (X) FIVE (5) sheets of drawings.
- (X) Preliminary Amendment.
- (X) A copy of Declaration and Power of Attorney from the prior application is enclosed.
- (X) Return prepaid postcard.

CLAIMS AS FILED

FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$ 770	\$ 770
Total Claims	4 - 20 =	0 ×	\$ 18	\$ 0
Independent Claims	1 - 3 =	0 ×	\$ 86	\$ 0
If application contains any multiple dependent claims(s), then add			\$ 290	\$ 0
For a Large Entity:	TOTAL FILING FEE			\$ 770

- (X) A check in the amount of \$ 770 to cover the filing fee is enclosed.
- (X) The commissioner is authorized to charge any additional necessary fee to Account No. 50-0710 (Order No. JCLA10375-D). A duplicate copy of this sheet is enclosed.

Correspondence address:
J.C. Patents
4 Venture, Suite 250
Irvine, California 92618
Telephone: (949) 660-0761


Jiawei Huang
Registration No. 43,330

17439 U.S. PTO
032204

22390 U.S. PTO
10/805933
032204

J.C. PATENTS
4 VENTURE, SUITE 250
IRVINE, CALIFORNIA 92618
TEL. (949) 660-0761
FAX (949) 660-0809

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING BY "EXPRESS MAIL"

Docket No. : JCLA10375-D
Inventor(s) : YU-LUNG YU ;
JOSEPH NEE ;

For : WAFER LEVEL TESTING AND BUMPING PROCESS
"Express Mail"
Mailing Label No. : EV 301018624 US
Date of Deposit : March 22, 2004

I hereby certify that the accompanying

Transmittal in Duplicate; Specification in 15 page(s); 5 sheets of drawing(s); Copy of Declaration and Power of Attorney from prior application; Preliminary Amendment; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Commissioner for Patents, P.O. BOX 1450, Alexandria, VA 22313-1450


Michelle Chang